for Automotive Electronics

SPECIFICATIONS

Approved By Verified By Re-checked By Checked By			,						(
Sunlord Part Number Customer Part Number Weight/MPQ 4.55g/pcs Typ., 500pcs/reel [New Released, Revised] This SPEC is total 14 pages.] [RoHS Compliant Parts] Approved By Checked By Issued By Checked By Issued By Checked By E-Mail: sunlord@sunlordinc.com For Customer approval Only] Date: Dualification Status: Full Restricted Rejected Approved By Verified By Re-checked By Checked By Re-checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By Checked By	Customer							•		
Customer Part Number Weight/MPQ	Product Name			Autom	otive Mc	olded SMD	Power	· Inductor		
Weight/MPQ 4.55g/pcs Typ., 500pcs/reef SPEC No.: AMP0906230000 [This SPEC is total 14 pages.] [RoHS Compliant Parts] Approved By Checked By Issued By Shenzhen Sunlord Electronics Co., Ltd. ddress: Sunlord Industrial Park, Dafuyuan Industrial Zone, Guanlan, Shenzhen, China 518110 si: +86-755-29832333 Fax: +86-755-82269029 E-Mail: sunlord@sunlordinc.com For Customer approval Only] Date: Qualification Status: Full	Sunlord Part N	umber			AM	P1205H S	eries			
[New Released, Revised] SPEC No.: AMP0906230000 [This SPEC is total 14 pages.] [RoHS Compliant Parts] Approved By Checked By Issued By Shenzhen Sunlord Electronics Co., Ltd. ddress: Sunlord Industrial Park, Dafuyuan Industrial Zone, Guanlan, Shenzhen, China 518110 si: +86-755-29832333 Fax: +86-755-82269029 E-Mail: sunlord@sunlordinc.com For Customer approval Only] Date: Qualification Status: Full Restricted Rejected Approved By Verified By Re-checked By Checked By	Customer Part	Number						(\(\)		
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	Version Change History											
Rev.	Date	Item	Changed Contents	Change Reasons	Drawing	Check	Approval					
01	1	1	1	New release	Yuqiang Tian	Yubo Su	Yubo Su					



(Content)										
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1 Scope

1.1 Scope of parts

This specification applies to the AMP1205H Series of Automotive Molded SMD power inductor based on AEC-Q200.

1.2 Scope of application

Product numbers recorded in this specification are used for automotive applications.

1.3 Operating and storage temperature

The part temperature (ambient + temp. rise) should not exceed 150 °C under worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

- 1) Operating and storage temperature range (individual chip without packing): -55°C ~ +150°C (including self-heating).
- 2) Storage temperature range (packaging conditions): -10°C~+40°C and RH 70% (Max.).
- 1.4 MSL: level1.

2 Product Description and Identification (Part Number)

1) Description:

AMP1205H series of Automotive Molded SMD power inductor.

2) Product Identification (Part Number)

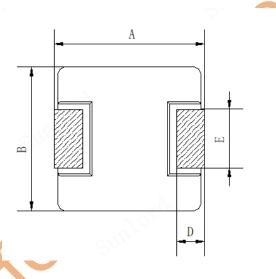
AMP	1205	Н	3R3	М	Т	
1	2	3	4	(5)	6	7

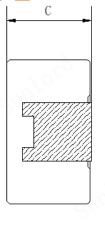
1	Product Type	AMP: Automotive Molded SMD Power Inductor
2	External Dimensions(L×W×H) [mm]	1205: 13.45×12.6×4.8mm
3	Feature type	H: H type material
4	Nominal Inductance	3R3: 3.3µH, 4R7: 4.7µH, 6R8: 6.8µ <mark>H</mark> , 100: 10.0µH
(5)	Inductance Tolerance	M: ±20%
6	Packing	T: tape & Reel
7	Special Process code	Standard product is blank

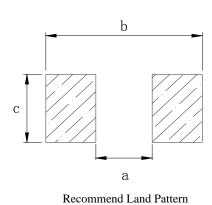
3 Shape and Dimensions

Dimensions and recommended PCB pattern for reflow soldering, please see Fig.3-1, Fig. 3-2 and Table 3-1.

Fig.3-1 Fig.3-2







[Table 3-1] (Unit: mm)

Series	А	В	С	D	E	а	b	С
AMP1205H	13.5±0.5	12.6±0.3	4.8±0.2	2.0±0.5	Refer to	8.3ref.	14.5ref.	5.5ref.
AIVII 1203I1	13.310.3	12.010.3	4.010.2	2.010.5	remarks	0.5/6/.	14.5161.	3.5iei.

Remarks

Series	E	Inductance
AMP1205H	3.8±0.5	R33/R68/R82/2R2
AIVIF 1205FI	5.0±0.3	3R3/4R7/6R8/8R2/100/150/220/330/470

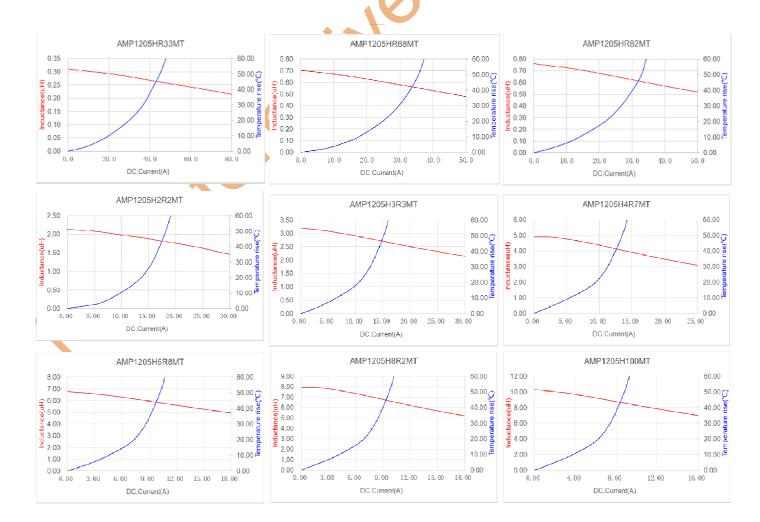
4 Electrical Characteristics

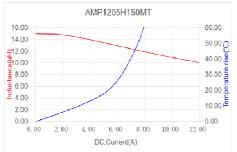
Part Number	Inductance	DC Res	DC Resistance Saturation Current		on Current	Heat Rating Current	Withstanding Voltage	
	100KHz/1V	Max.	Тур.	Max	Тур.	Тур.	Тур.	Marking
Units	μΗ	m	Ω		A	А	V_{DC}	
Symbol	L	DO	CR	I	sat	Irms	1	
AMP1205HR33MT	0.33±20%	1.26	0.70	65	70	40		R33
AMP1205HR68MT	0.68±20%	1.55	1.33	40	48	33		R68
AMP1205HR82MT	0.82±20%	1.67	1.37	31.2	39	30		R82
AMP1205H2R2MT	2.2±20%	4.70	4.00	24	28	17		2R2
AMP1205H3R3MT	3.3±20%	7.00	5.95	20.8	26	14		3R3
AMP1205H4R7MT	4.7±20%	9.00	7.65	16	20	12.5		4R7
AMP1205H6R8MT	6.8±20%	18.0	15.3	15.2	19	9.5	100	6R8
AMP1205H8R2MT	8.2±20%	20.0	17.0	14.4	18	9.0	() [*]	8R2
AMP1205H100MT	10±20%	22.0	18.7	12	15	8.2		100
AMP1205H150MT	15±20%	33.0	28.1	8.8	11	7.0		150
AMP1205H220MT	22±20%	50.0	43.0	8.0	10	5.5		220
AMP1205H330MT	33±20%	68.0	58.0	6.4	8	4.4		330
AMP1205H470MT	47±20%	88.0	75.0	4.8	6	3.5		470

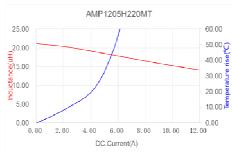
Note: %1: Rated current: Isat (Max.) or Irms(Typ.), whichever is smaller;

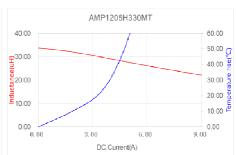
*2: Saturation Current: Typ. Value, DC current at which the inductance drops approximately 30% from its value without current;

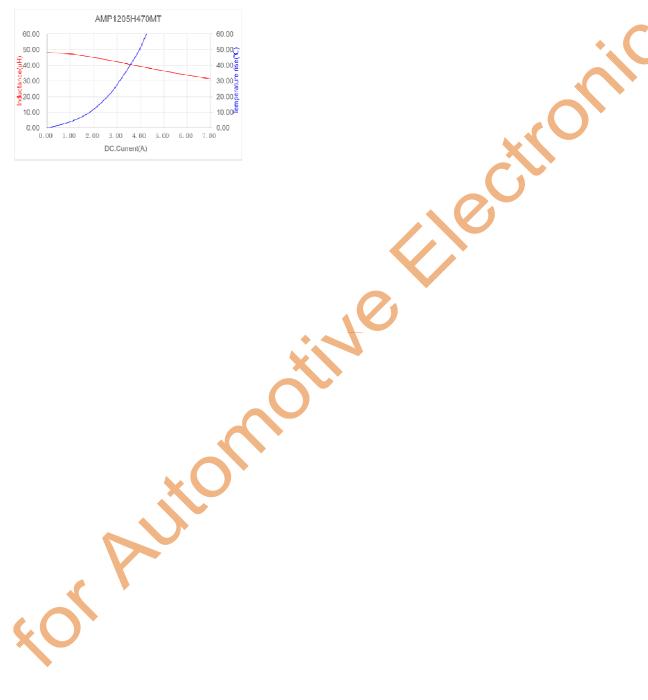
3: Heat Rating Current: DC current that causes an approximate ΔT of 40°C from 20°C ambient.











5 Test and Measurement Procedures

5.1 Test Conditions

- 5.1.1 Unless otherwise specified, the standard atmospheric conditions for measurement/test as:
 - a. Ambient Temperature: 20±15℃.
 - b. Relative Humidity: 65±20%.
 - c. Air Pressure: 86kPa to 106kPa.
- 5.1.2 If any doubt on the results, measurements/tests should be made within the following limits:
 - a. Ambient Temperature: 20±2°C.
 - b. Relative Humidity: 65±5%.
 - c. Air Pressure: 86kPa to 106kPa.

5.2 Visual Examination

Inspection Equipment: visual.

5.3 Electrical Test

- 5.3.1 Inductance (L)
 - a. Refer to Item 4.Test equipment: WK3260B LCR meter or equivalent.
 - b. Test Frequency and Voltage: refers to Item 4.
- 5.3.2 Direct Current Resistance (DCR)
 - a. Refer to Item 4.
 - b. Test equipment: HIOKI 3540 or equivalent.
- 5.3.3 Saturation Current (Isat)
 - Refer to Item 4.
 - b. Test equipment: WK3260B LCR meter or equivalent.
- 5.3.4 Temperature rise current (Irms)
 - Refer to Item 4.
 - b. Test equipment (see Fig. 5.3.4-1, Fig.5.3.4-2): Electric Power, Electric current meter, Thermometer.
 - c. Measurement method:
 - 1. Set test current to be 0 mA.
 - 2. Measure initial temperature of choke surface.
 - Gradually increase current and measure choke temperature for corresponding current.
 - 4. Definition of Temperature rise current: DC current that causes the temperature rise (ΔT) from ambient temperature.

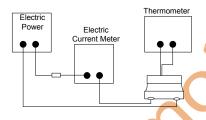


Fig. 5.3.4-1

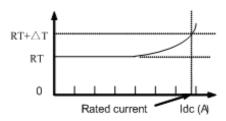
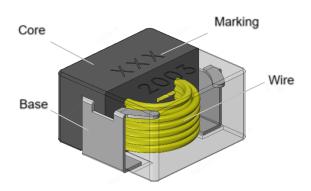


Fig. 5.3.4-2

6 Structure and material list

The structure and material list of AMP1205H products please refer to Fig.6-1 and Table 6-1.



[Table. 6-1]

Components	Material
Marking	1
Core	Alloy Sponge Powder
Wire	Polyurethane copper wire
Base	Copper plated with Sn

Fig.6-1

7 Product Marking

The product marking, please refer to **Fig.7-1.** XXX: Inductance, refer to specifications

2003: trace code



Fig.7-1

8 Reliability Test

8 R	eliability Test		
No.	Test Items	Test Methods	Requirements
1	Visual	Inspect the appearance at least 10X.	No visible mechanical damage
2	Physical Dimension	length, width, thickness of the components.	meet the specifications
3	Pre-and Post -Stress Electrical Test	Inductance of the components DC resistance of the components	(1)The electrical values before the test meet the specifications(2)The electrical values after the test meet the rate of change requirements; Inductance change:Within ±20%
4	Terminal strength	①Precondition: 3 reflow cycles;②Test condition:17.7N,X,Ydirect,60(+5)s,Speed:1.0mm/s.	No removal or split of the termination or other defects shall occur
5	Board Flex	①Precondition: 3 reflow cycles; ②Test condition: 2mm,60(+5)s.	No visible mechanical damage
6	Solder ability	Method 1: ①pretreatment:155°C,4h; ②245°C,5(-0.5,+0)s,25 ± 6 mm/s; ③Solder:Sn/3.0Ag/0.5Cu. Method 2: ①Steam aging:8h ±15min; ②245°C,5(-0.5,+0)s,25 ± 6 mm/s; ③Solder:Sn/3.0Ag/0.5Cu.	Wetting shall be exceeded 95% coverage
		Method 3: ①Steam aging:8h ±15min; ②260°C,30±5s,25 ± 6 mm/s; ③Solder:Sn/3.0Ag/0.5Cu.	No more than 5% of the solderable termination exhibits exposed underlying, nonwettable base metal or metallization layers or portions of the ceramic substrate after exposure to molten solder
7	Resistance to Soldering Heat	Method 1: Max 260℃/10s, 3 times.Solder:Sn/3.0Ag/0.5Cu. Note: Reflow Profile refer to reflow profile 1	(1)No visible mechanical damage (2) Inductance change: Within ±20%
8	High Frequency Vibration	Reflow 3 times,10~2000Hz,5g,20min/Cycle,4 hours in each 3 mutually perpendicular directions (total of 12 hours) .	(3) DCR: Satisfy electrical characteristic.
9	Mechanical Shock	Reflow 3 times,Half sine shock pulse,100g,6ms,6 shocks in each 3 mutually perpendicular directions (total of 18 shocks).	

Automotive Molded SMD Power Inductor Business Categories: Level 0 (general confidential)

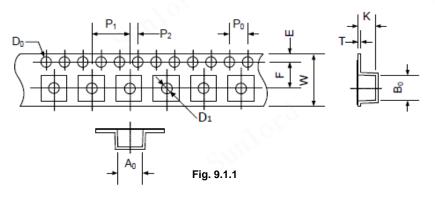
	Т	Busiliess Categories. Level o (general confider	·······/
10	Temperature Cycling	Reflow 3 times, ambient temperature -55°C/(30min), ambient temperature+150°C/(30min), transforming interval:20s,1000 cycles.	
11	Low Temperature Exposure (Storage)	①Precondition: 3 reflow cycles;②Test condition: ambient temperature-55±2°C,1000(+24)hours.	
12	High Temperature Exposure (Storage)	①Precondition: 3 reflow cycles; ②Test condition: ambient temperature 150±2°C,1000(+24)hours.	(1) No visible mechanical damage(2) Inductance change: Within ±20%(3) DCR: Satisfy electrical characteristic.
13	Biased Humidity	Reflow 3 times, ambient temperature85°C,85%RH, 1000 hours.	
14	Operational Life	Reflow 3 times,ambient temperature125±2°C,1000(+24)hours, rated current.	× (O)
15	MSL	Team A: ①Pre- and Post- Stress Electrical and Visual Test; ②High temperature Bake:125+5/-0°C,24 h; ③Temperature&Humidity Soak:85°C,85%RH,168 h; ④Reflow:MAX.260°C/10 s, 3 times.	(1) No visible mechanical damage (2) Inductance change: Within ±20%
16	Flammability	Refer to MIL-STD-202 Method 111、UL-94	 t1 or t2:≤10s; t1 plus t2 for the 5 specimens:≤50s; t2+t3 for each specimen:≤30s; No after-flame or after-glow of any specimen up to the holding clamp; No cotton indicator ignited by flaming particles or drops.
17	ESD Test	HBM ESD discharge waveform, each 1 time of +/- polarity. Voltage refer to 4KV: Inductance≥22uh; 8KV: Inductance<22uh;	(1) No visible mechanical damage(2) Inductance change: Within ±20%(3) DCR: Satisfy electrical characteristic.
18	Electrical characteristics	ambient temperature 25°C(15+3min) →ambient temperature -55°C(15+3min) →ambient temperature +150°C(15+3min).	Inductance change should be within ±20% of reference value measuring at 25℃
19	solvent resistance test	Add Aqueous wash chemical. OKEM Clean or equivalent. Do not use banned solvents.	 No specified markings which are missing in whole or in part, faded, smeared, blurred, or shifted (dislodged) to the extent; No specimen shall have cracks, separations, crazing, swelling, softening, and degradation of body material, end caps and seals if present.

9 Packaging and Storage

9.1 Tape and Reel Packaging Dimensions

9.1.1 Taping Dimensions (Unit: mm)

Please refer to Fig. 9.1.1 and Table 9.1.1.



[Table9.1.1] Unit: mm

Series	A ₀	B ₀	W	E	F	P ₀	P ₁
AMP1205H	13.1±0.1	14±0.1	24±0.3	1.75±0.1	11.5±0.1	4.0±0.1	16.0±0.1
Series	P ₂	D ₀	Т	K	D1	1	1
AMP1205H	2.0±0.10	1.55±0.1	0.5±0.05	5.4±0.1	1.55±0.1	1	1

9.1.2 Direction of rolling

Please refer to Fig. 9.1.2

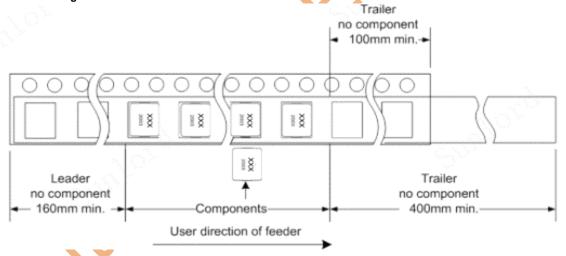


Fig. 9.1.2

9.1.3 Reel Dimensions (Unit: mm)

Please refer to Fig. 9.1.3.

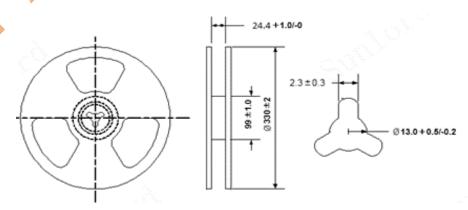


Fig.9.1.3

9.1.4 Top tape strength

Peel-off strength: 10~130gf.

Peel-off angle: 165°~180°, refers to Fig. 9.1.4.

Peel-off speed: 300mm/min.

9.1.5 The number of components

A tape & reel package contains 500 inductors.

9.1.6 The allowable number of empty chip cavities: 0 chip.

9.2 Packing Documents and Marking

9.2.1Packing Documents

Packing documents include the following:

- 1) Packaging list
- 2) Certificate of compliance (COC)

9.2.2Packing QTY.

- 1) Inner Box: 1 reel in each box.
- 2) Outer Box:5 inner boxes in each outer case.
- 3) 5 reels in each outer case.

9.2.3Marking

1)Marking label information on reels includes (see Fig.9.2.3-1~2):

Fig.9.2.3-2a: Shipping labels

- a). P/O No.
- b). Customer Part No.
- c). Sunlord Part No.
- d). Quantity.
- e). Lot No.
- f). Date code
- g). Inspection stamp
- h). MFG address as 'Made In China'.

Fig.9.2.3-2b: Production label

- a). P/N.
- b). Quantity..
- c). Lot No.
- d). Inspe No
- e). Inspection stamp
- f). MFG address as 'Made In China'.
- g). sequence number

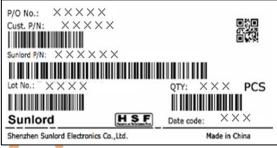


Fig.9.2.3-2a

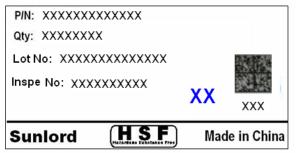
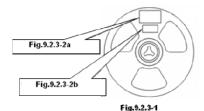


Fig.9.2.3-2b

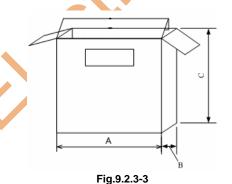


Fig. 9.1.4



[Table 9.2.3-1]

Packaging type	A(mm)	B(mm)	C(mm)
Inner box	340	40	340



[Table 9.2.3-2]

Packaging type	L(mm)	W(mm)	H(mm)
TYP1	335	335	200

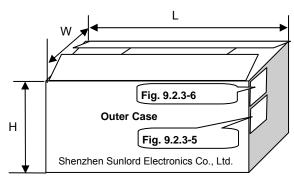


Fig. 9.2.3-4

- 2)Marking label information on inner box
 - a). Inner box please refers to Fig.9.2.3-3 and Table 9.2.3-1.
 - b). Marking Label on inner box

N/A

3)Marking on outer case (see Fig.9.2.3-4~6):

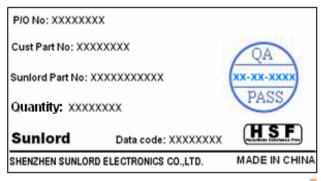
Out case size pleases reefers to Table 9.2.3-2.

- a). Manufacturer: Sunlord ID:
 - "Shenzhen Sunlord Electronics Co., Ltd."
- b). Packing label include the following:
 - i) Customer
 - ii) Manufacturer
 - iii) Date code
 - iv) C/No.

Example; "1/10" means that this case is the 1st

of total 10 cases

- v) P/O No.
- vi) Customer Part No.
- vii) Sunlord Part No.
- viii) Quantity.
- ix) Inspection Stamp.



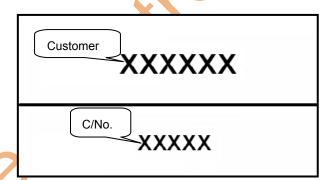


Fig.9.2.3-5

Automotive Molded SMD Power Inductor Business Categories: Level 0 (general confidential)

10 Visual inspection standard of product

File No: Effective date:		Applied to Automotive Molded SMD Power Inductor		
1	Core defect	L , w	The defect length and width (L and W) more than 2mm, NG.	AQL=0.065
2	Core crack		Cracks can be seen on the bottom surface by eyes, NG.	AQL=0.065
3	Electrode surface dirt		dirt can be seen on the electrode surface by eyes, NG.	AQL=0.065
4	Marking defect	2R 200	The content of marking is indistinct or indistinguishable, NG;	AQL=0.065

11 Recommended Soldering Technologies

11.1Re-flowing Profile:

△ Preheat condition: 150 ~200°C/60~180sec.

△ Allowed time above 217°C: 60~150sec.

△ Allowed time above 255°C: 30sec. ref.

 \triangle Max temp: 260°C.

 \triangle Max time at max temp: 5sec.

Solder paste: Sn/3.0Ag/0.5Cu. △ Allowed Reflow time: 3x max:

Please refer to Fig. 11.1-1.

[Note: The reflow profile in the above table is only for qualification and is not meant to specify board assembly profiles. Actual board assembly profiles must be based on the customer's specific board design, solder paste and process, and should not exceed the parameters as the Reflow profile shows.]

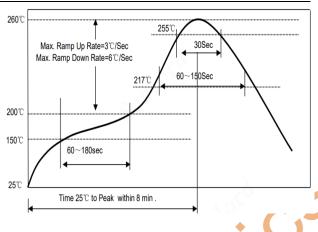


Fig. 11.1-1

11.2 Iron Soldering Profile

 \triangle Iron soldering power: Max. 30W.

△ Pre-heating: 150°C/60sec.

△ Soldering Tip temperature: 350°C Max.

△ Soldering time: 3sec. Max.

△ Solder paste: Sn/3.0Ag/0.5Cu.

 \triangle Max.1 times for iron soldering:

Please refer to Fig. 11.2-1.

[Note: Take care not to apply the tip of the soldering iron to the terminal electrodes.]

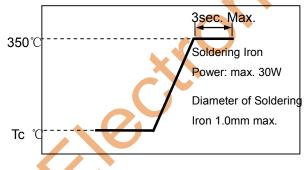


Fig. 11.2-1

12 Precautions

12.1 Surface mounting

- Mounting and soldering condition should be checked beforehand.
- Applicable soldering process to this product is reflow soldering only.
- Recommended conditions for repair by soldering iron:

Preheat the circuit board with product to repair at 150°C for about 1 minute.

Put soldering iron on the land-pattern.

Soldering iron's temperature: 350°C maximum/Duration: 3 seconds maximum/1 time for each terminal.

The soldering iron should not directly touch the inductor.

Product once removes from the circuit board may not be used again.

12.2 Handing

- Keep the products away from all magnets and magnetic objects.
- Be careful not to subject the products to excessive mechanical shocks.
- Please avoid applying impact to the products after mounted on pc board.
- Avoid ultrasonic cleaning.

12.3 Storage

- To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
- Recommended conditions: -10°C~40°C, 70%RH (Max.).
- Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used with one year from the time of delivery.
- In case of storage over 6 months, solderability shall be checked before actual usage.

12.4 Regarding Regulations

- Any Class- I or Class- II ozone-depleting substance (ODS) listed in the Clean Air Act in US for regulation is not included in the products or applied to the products at any stage of whose manufacturing processes.
- Certain brominated flame retardants (PBBs, PBDEs) are not used at all.
- The products of this specification are not subject to the Export Trade Control Order in China or the Export Administration Regulations in US.

12.5 Guarantee

- The guaranteed operating conditions of the products are in accordance with the conditions specified in this specification.
- Please note that Sunlord takes no responsibility for any failure and/or abnormality which is caused by use under other than the aforesaid operating conditions.
- 12.6 Please make sure to record the lot number on the label when using Sunlord's products in order for good traceability.